

## 3.3 V, SILICON GERMANIUM MMIC WIDE BAND AMPLIFIER

### DESCRIPTION

The  $\mu$ PC3242TB is a silicon germanium monolithic integrated circuit designed as IF amplifier for DBS LNB. This device exhibits low noise figure and high power gain characteristics. This IC is manufactured using our UHSK3 (Ultra High Speed Process) silicon germanium bipolar process.

### FEATURES

- Low current :  $I_{CC} = 4.3$  mA TYP.
- Power gain :  $G_P = 22$  dB TYP. @  $f = 1.0$  GHz  
:  $G_P = 22$  dB TYP. @  $f = 2.2$  GHz
- Gain flatness :  $\Delta G_P = 0.4$  dB TYP. @  $f = 1.0$  to  $2.2$  GHz
- Noise figure :  $NF = 4.0$  dB TYP. @  $f = 1.0$  GHz  
:  $NF = 4.0$  dB TYP. @  $f = 2.2$  GHz
- High linearity :  $P_{O(1\text{ dB})} = -7.5$  dBm TYP. @  $f = 1.0$  GHz  
:  $P_{O(1\text{ dB})} = -9.5$  dBm TYP. @  $f = 2.2$  GHz
- Supply voltage :  $V_{CC} = +3.0$  to  $+3.6$  V
- Port impedance : input/output  $50\ \Omega$

### APPLICATIONS

- IF amplifiers in DBS LNB, other L-band amplifiers, etc.

### ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
$\mu$ PC3242TB-E3	$\mu$ PC3242TB-E3-A	6-pin super minimold (Pb-Free)	C3Z	<ul style="list-style-type: none"> <li>• Embossed tape 8 mm wide</li> <li>• Pin 1, 2, 3 face the perforation side of the tape</li> <li>• Qty 3 kpcs/reel</li> </ul>

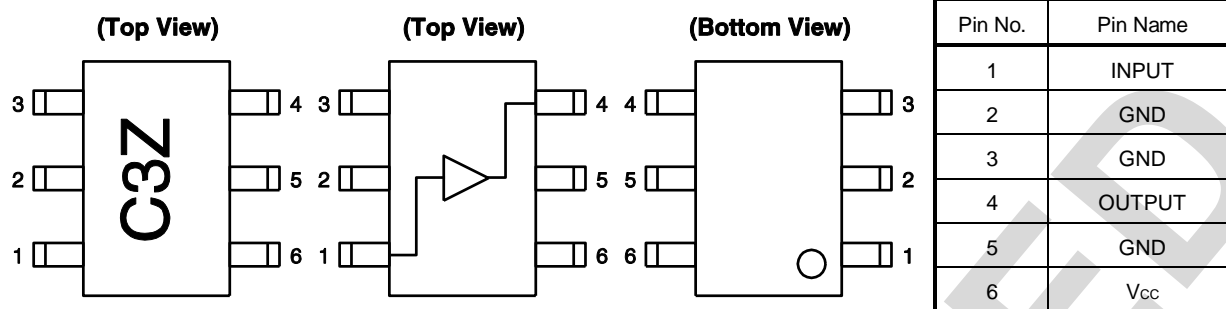
**Remark** To order evaluation samples, please contact your nearby sales office.

Part number for sample order:  $\mu$ PC3242TB-A

**Caution: Observe precautions when handling because these devices are sensitive to electrostatic discharge**

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

## PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



**PRODUCT LINE-UP OF 5 V or 3.3 V-BIAS SILICON MMIC WIDE BAND AMPLIFIER**  
 (T<sub>A</sub> = +25°C, V<sub>CC</sub> = +5.0 V or +3.3 V, Z<sub>s</sub> = Z<sub>L</sub> = 50 Ω)

Part No.	V <sub>CC</sub> (V)	I <sub>CC</sub> (mA)	G <sub>P</sub> (dB)	NF (dB)	P <sub>O</sub> (sat) (dBm)	P <sub>O</sub> (1 dB) (dBm)	Package	Marking
μPC2711TB	+5.0	12.0	13.0 (1.0 GHz)	5.0 (1.0 GHz)	+1.0 (1.0 GHz)	–	6-pin super minimold	C1G
μPC2712TB		12.0	20.0 (1.0 GHz)	4.5 (1.0 GHz)	+3.0 (1.0 GHz)	–		C1H
μPC3215TB		14.0	20.5 (1.5 GHz)	2.3 (1.5 GHz)	+3.5 (1.5 GHz)	+1.5 (1.5 GHz)		C3H
μPC3224TB		9.0	21.5 (1.0 GHz)	4.3 (1.0 GHz)	+4.0 (1.0 GHz)	–3.5 (1.0 GHz)		C3K
			21.5 (2.2 GHz)	4.3 (2.2 GHz)	+1.5 (2.2 GHz)	–5.5 (2.2 GHz)		
μPC3227TB	4.8	22.0 (1.0 GHz)	4.7 (1.0 GHz)	–1.0 (1.0 GHz)	–6.5 (1.0 GHz)	C3P		
		22.0 (2.2 GHz)	4.6 (2.2 GHz)	–3.5 (2.2 GHz)	–8.0 (2.2 GHz)			
μPC3240TB	+3.3	13.0	25.0 (1.0 GHz)	4.3 (1.0 GHz)	–	+1.0 (1.0 GHz)	C3W	
24.5 (2.2 GHz)			4.5 (2.2 GHz)	–	–4.0 (2.2 GHz)			
μPC3242TB		4.3	22.0 (1.0 GHz)	4.0 (1.0 GHz)	–0.5 (1.0 GHz)	–7.5 (1.0 GHz)	C3Z	
	22.0 (2.2 GHz)		4.0 (2.2 GHz)	–4.0 (2.2 GHz)	–9.5 (2.2 GHz)			

**Remark** Typical performance. Please refer to **ELECTRICAL CHARACTERISTICS** in detail.

**ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Conditions	Ratings	Unit
Supply Voltage	V <sub>CC</sub>	T <sub>A</sub> = +25°C	4.0	V
Total Circuit Current	I <sub>CC</sub>	T <sub>A</sub> = +25°C	10	mA
Power Dissipation	P <sub>D</sub>	T <sub>A</sub> = +85°C <b>Note</b>	270	mW
Operating Ambient Temperature	T <sub>A</sub>		–40 to +85	°C
Storage Temperature	T <sub>stg</sub>		–55 to +150	°C
Input Power	P <sub>in</sub>	T <sub>A</sub> = +25°C	–10	dBm

**Note** Mounted on double-sided copper-clad 50 × 50 × 1.6 mm epoxy glass PWB

**RECOMMENDED OPERATING RANGE**

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Supply Voltage	V <sub>CC</sub>		+3.0	+3.3	+3.6	V
Operating Ambient Temperature	T <sub>A</sub>		–40	+25	+85	°C

**ELECTRICAL CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$ ,  $V_{CC} = +3.3\text{ V}$ ,  $Z_s = Z_L = 50\ \Omega$ , unless otherwise specified)

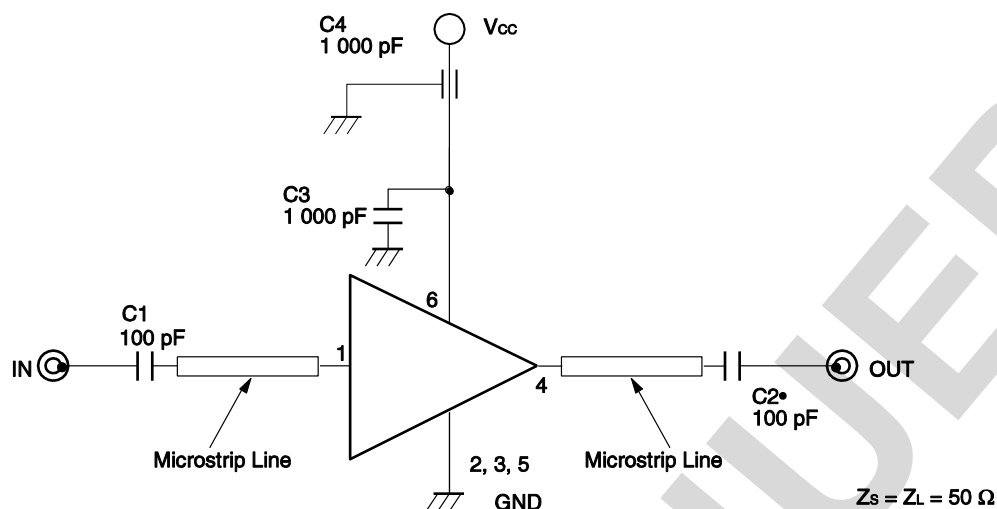
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	$I_{CC}$	No input signal	3.6	4.3	5.0	mA
Power Gain 1	$G_{P1}$	$f = 0.25\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	19	22	25	dB
Power Gain 2	$G_{P2}$	$f = 1.0\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	19	22	25	
Power Gain 3	$G_{P3}$	$f = 1.8\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	19	22	25	
Power Gain 4	$G_{P4}$	$f = 2.2\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	19	22	25	
Gain 1 dB Compression Output Power 1	$P_{O(1\text{ dB})1}$	$f = 1.0\text{ GHz}$	-10	-7.5	-	dBm
Gain 1 dB Compression Output Power 2	$P_{O(1\text{ dB})2}$	$f = 2.2\text{ GHz}$	-12.5	-9.5	-	
Noise Figure 1	NF1	$f = 1.0\text{ GHz}$	-	4.0	4.8	dB
Noise Figure 2	NF2	$f = 2.2\text{ GHz}$	-	4.0	4.8	
Isolation 1	ISL1	$f = 1.0\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	31	36.5	-	dB
Isolation 2	ISL2	$f = 2.2\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	34	40.5	-	
Input Return Loss 1	$RL_{in1}$	$f = 1.0\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	10	14	-	dB
Input Return Loss 2	$RL_{in2}$	$f = 2.2\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	6	8.5	-	
Output Return Loss 1	$RL_{out1}$	$f = 1.0\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	8	11	-	dB
Output Return Loss 2	$RL_{out2}$	$f = 2.2\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	8	11	-	

**STANDARD CHARACTERISTICS FOR REFERENCE**

( $T_A = +25^\circ\text{C}$ ,  $V_{CC} = +3.3\text{ V}$ ,  $Z_s = Z_L = 50\ \Omega$ , unless otherwise specified)

Parameter	Symbol	Test Conditions	Reference Value	Unit
Power Gain 5	$G_{P5}$	$f = 2.6\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	20.5	dB
Power Gain 6	$G_{P6}$	$f = 3.0\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	19	
Gain Flatness	$\Delta G_P$	$f = 1.0\text{ to }2.2\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	0.4	dB
Saturated Output Power 1	$P_{O(sat)1}$	$f = 1.0\text{ GHz}$ , $P_{in} = -15\text{ dBm}$	-0.5	dBm
Saturated Output Power 2	$P_{O(sat)2}$	$f = 2.2\text{ GHz}$ , $P_{in} = -15\text{ dBm}$	-4.0	
K factor 1	K1	$f = 1.0\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	2.5	-
K factor 2	K2	$f = 2.2\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	3.4	-
Output 3rd Order Intercept Point 1	OIP <sub>31</sub>	$f_1 = 1\ 000\text{ MHz}$ , $f_2 = 1\ 001\text{ MHz}$	1.5	dBm
Output 3rd Order Intercept Point 2	OIP <sub>32</sub>	$f_1 = 2\ 200\text{ MHz}$ , $f_2 = 2\ 201\text{ MHz}$	-0.5	
Input 3rd Order Intercept Point 1	IIP <sub>31</sub>	$f_1 = 1\ 000\text{ MHz}$ , $f_2 = 1\ 001\text{ MHz}$	-20	dBm
Input 3rd Order Intercept Point 2	IIP <sub>32</sub>	$f_1 = 2\ 200\text{ MHz}$ , $f_2 = 2\ 201\text{ MHz}$	-22	
2nd Order Intermodulation Distortion	IM <sub>2</sub>	$f_1 = 1\ 000\text{ MHz}$ , $f_2 = 1\ 001\text{ MHz}$ , $P_{in} = -40\text{ dBm/ tone}$	22	dBc
2nd Harmonics	$2f_0$	$f_0 = 1.0\text{ GHz}$ , $P_{in} = -40\text{ dBm}$	28.5	dBc

## TEST CIRCUIT



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

### COMPONENTS OF TEST CIRCUIT FOR MEASURING ELECTRICAL CHARACTERISTICS

	Type	Value
C1, C2	Chip Capacitor	100 pF
C3	Chip Capacitor	1 000 pF
C4	Feed-through Capacitor	1 000 pF

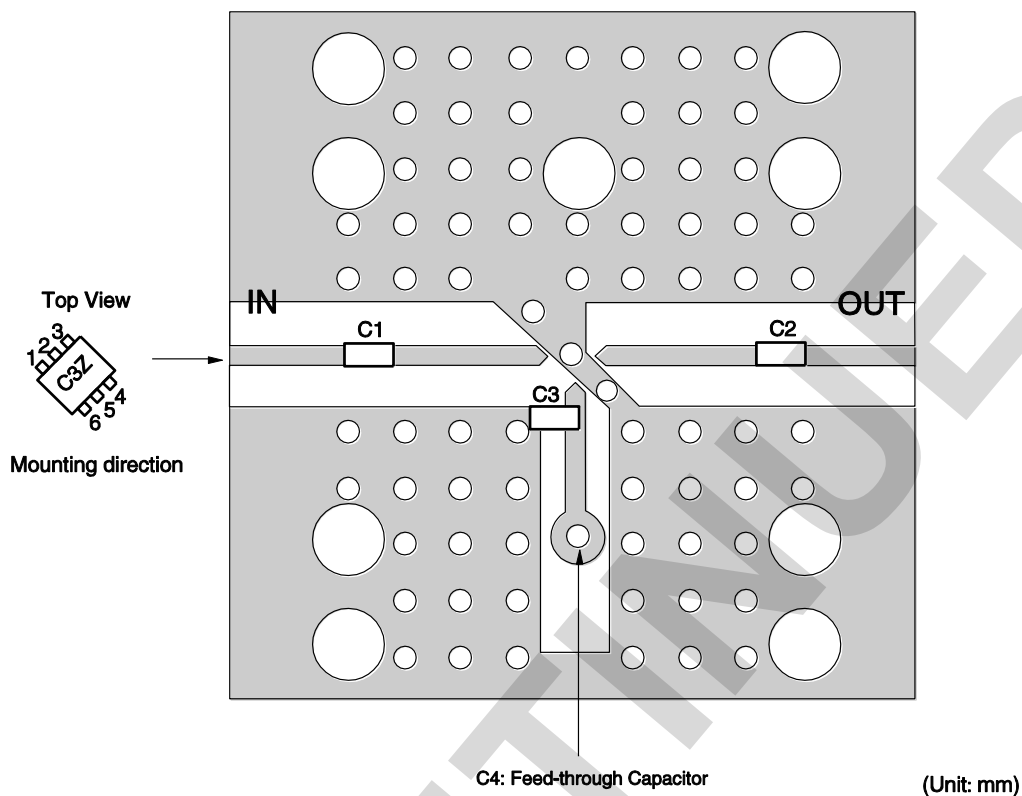
### CAPACITORS FOR THE V<sub>CC</sub>, INPUT AND OUTPUT PINS

Capacitors of 1 000 pF are recommendable as the bypass capacitor for the V<sub>CC</sub> pin and the coupling capacitors for the input and output pins.

The bypass capacitor connected to the V<sub>CC</sub> pin is used to minimize ground impedance of V<sub>CC</sub> pin. So, stable bias can be supplied against V<sub>CC</sub> fluctuation.

The coupling capacitors, connected to the input and output pins, are used to cut the DC and minimize RF serial impedance. Their capacitances are therefore selected as lower impedance against a 50 Ω load. The capacitors thus perform as high pass filters, suppressing low frequencies to DC.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



COMPONENT LIST

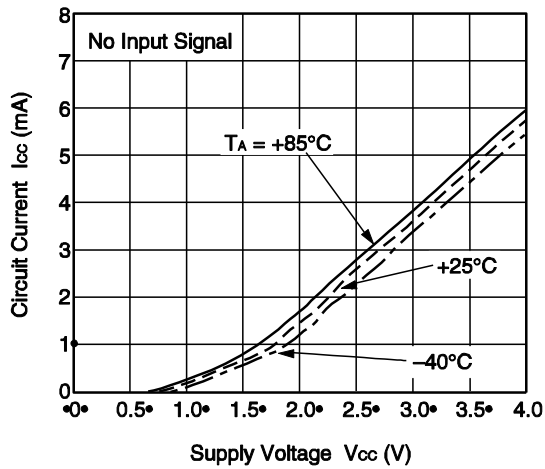
	Type	Value	Size
C1, C2	Chip Capacitor	100 pF	1608
C3	Chip Capacitor	1 000 pF	1608
C4	Feed-through Capacitor	1 000 pF	—

Notes

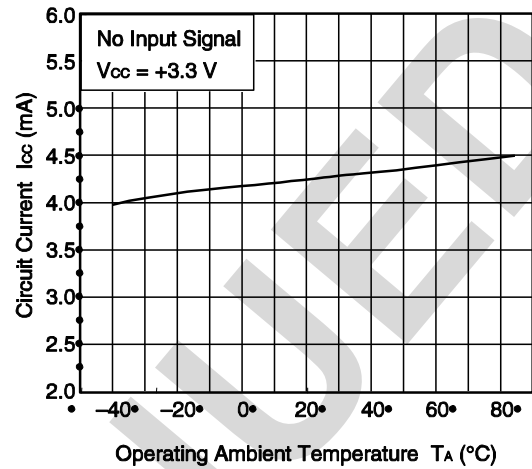
1. 30 × 30 × 0.4 mm double sided 35  $\mu$  m copper clad polyimide board.
2. Back side: GND pattern
3. Au plated on pattern
4.  $\phi$  O: Through holes

TYPICAL CHARACTERISTICS ( $T_A = +25^\circ\text{C}$ ,  $V_{CC} = +3.3\text{ V}$ ,  $Z_S = Z_L = 50\ \Omega$ , unless otherwise specified)

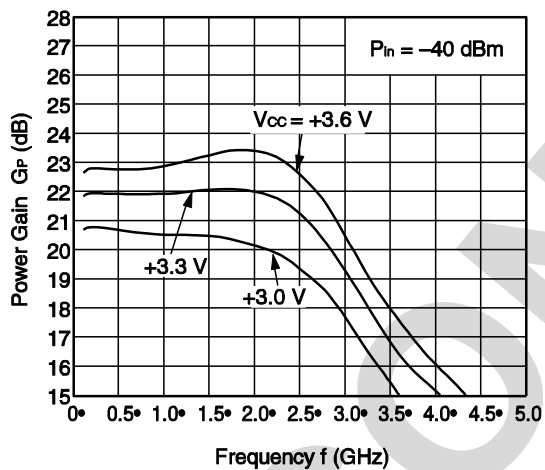
CIRCUIT CURRENT vs. SUPPLY VOLTAGE



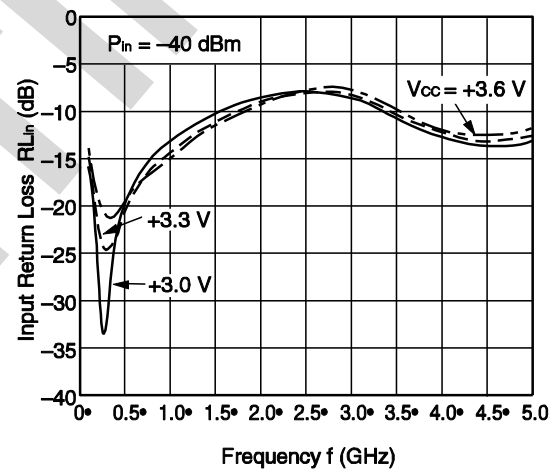
CIRCUIT CURRENT vs. OPERATING AMBIENT TEMPERATURE



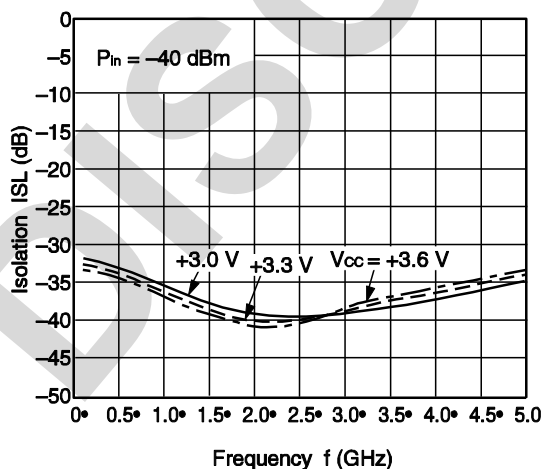
POWER GAIN vs. FREQUENCY



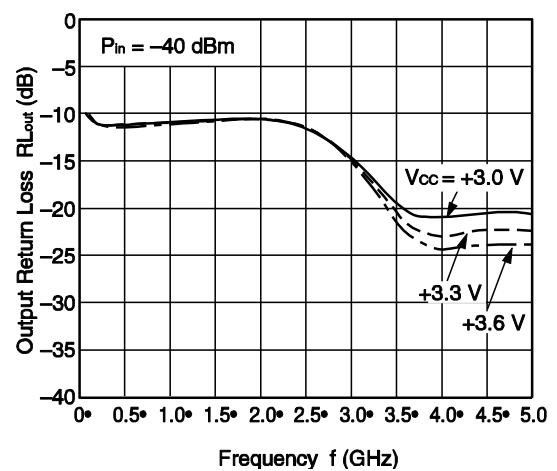
INPUT RETURN LOSS vs. FREQUENCY



ISOLATION vs. FREQUENCY

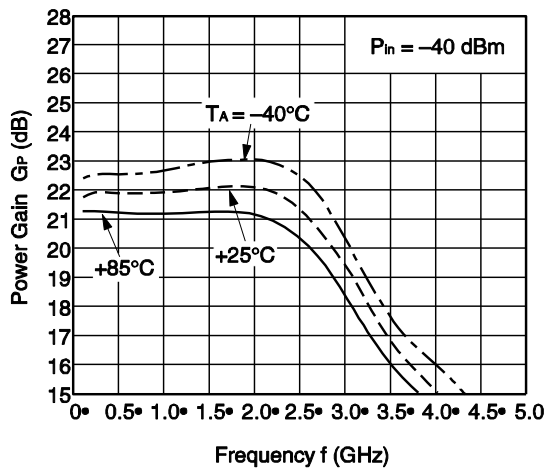


OUTPUT RETURN LOSS vs. FREQUENCY

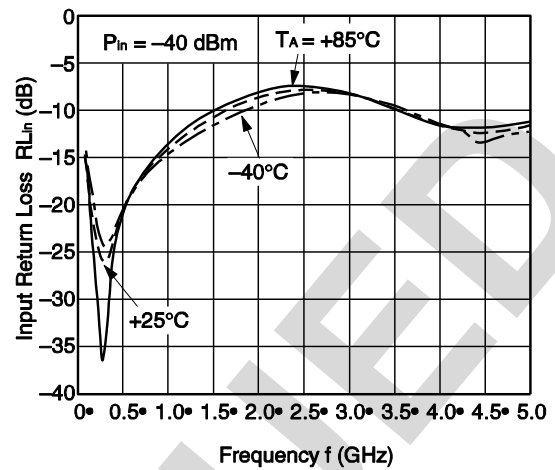


**Remark** The graphs indicate nominal characteristics.

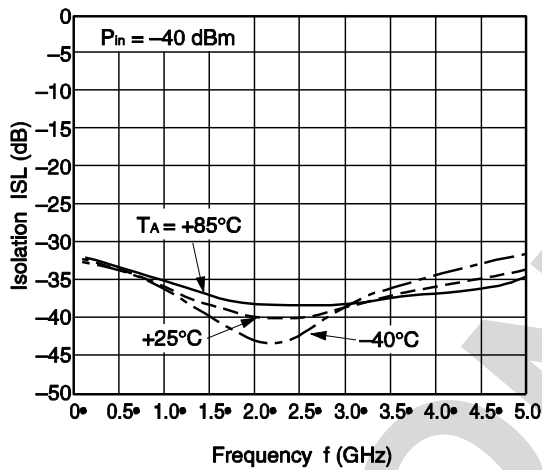
POWER GAIN vs. FREQUENCY



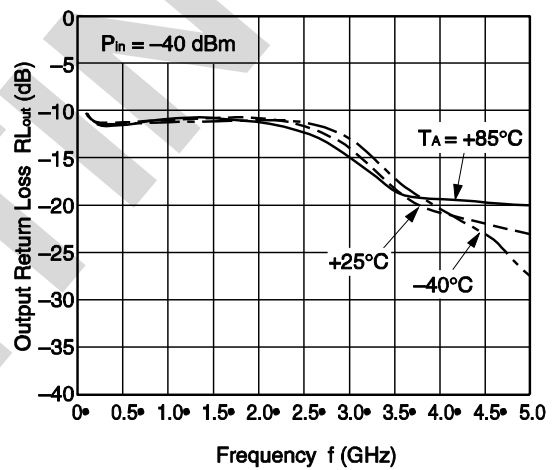
INPUT RETURN LOSS vs. FREQUENCY



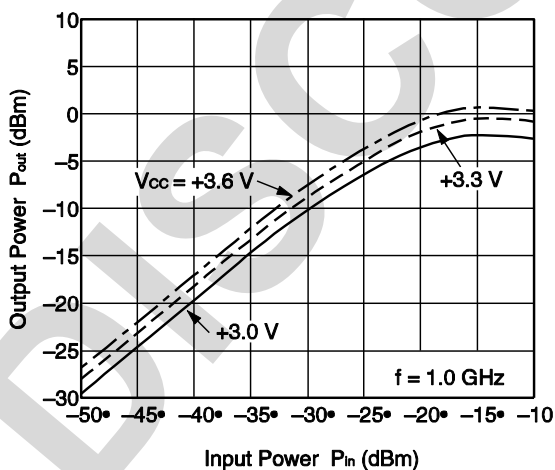
ISOLATION vs. FREQUENCY



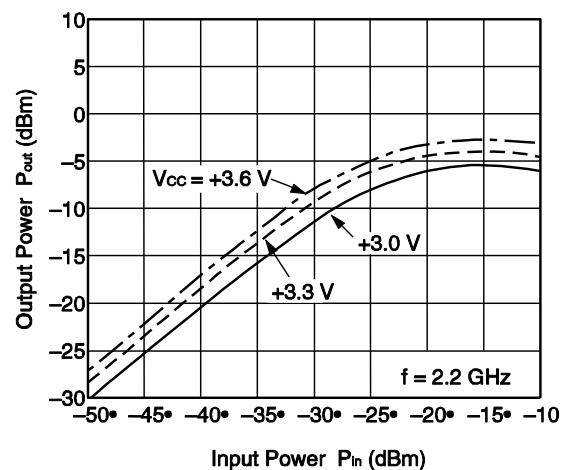
OUTPUT RETURN LOSS vs. FREQUENCY



OUTPUT POWER vs. INPUT POWER

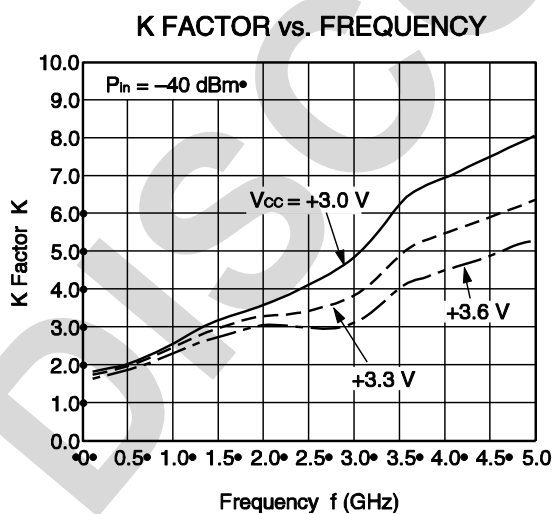
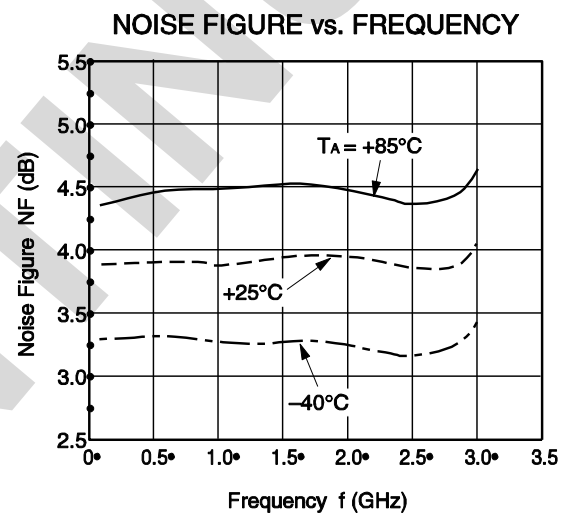
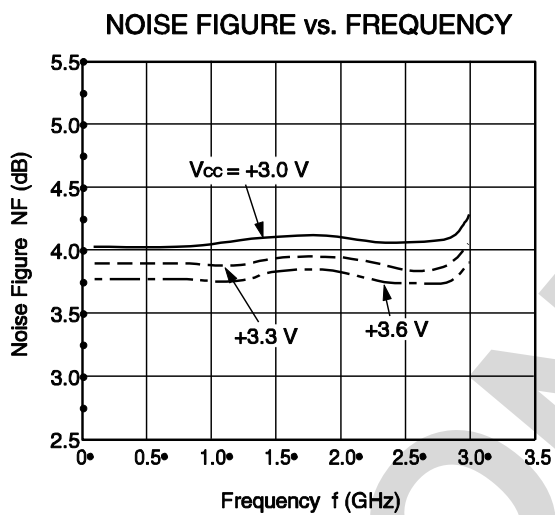
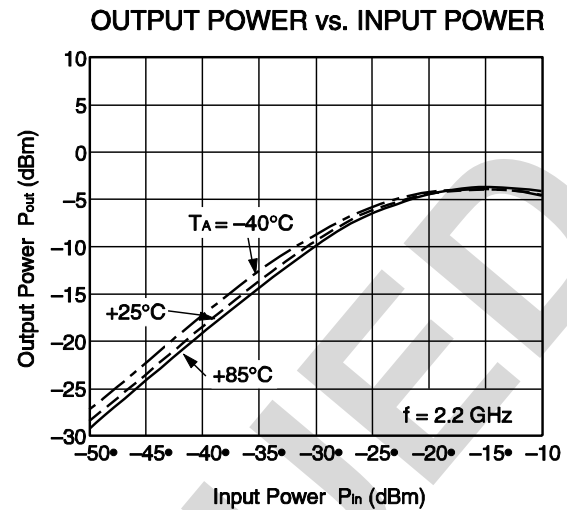
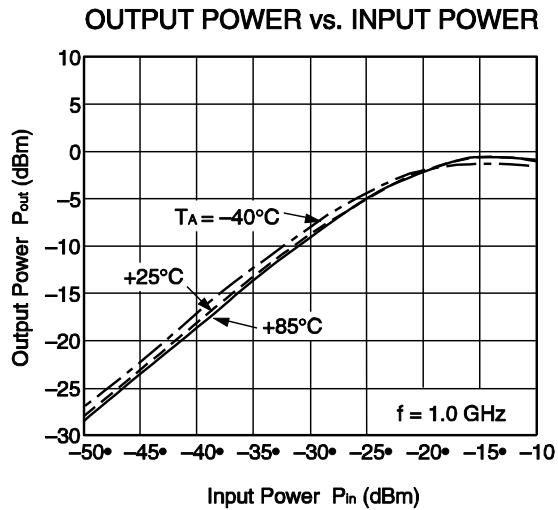


OUTPUT POWER vs. INPUT POWER

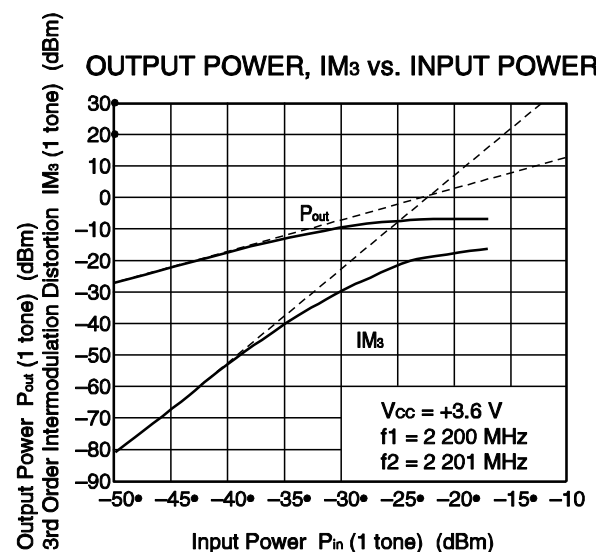
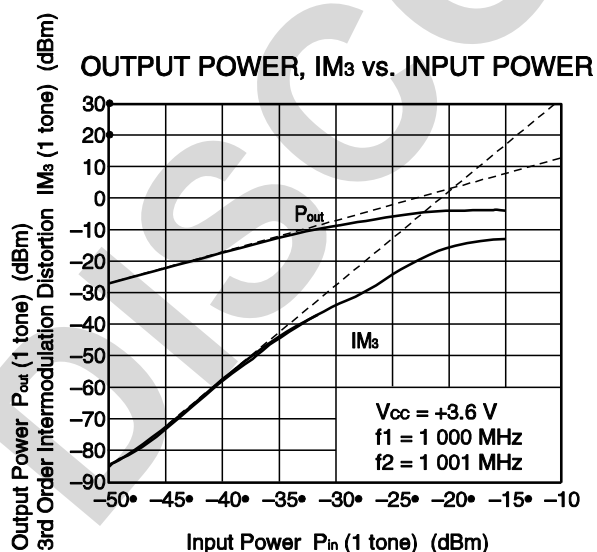
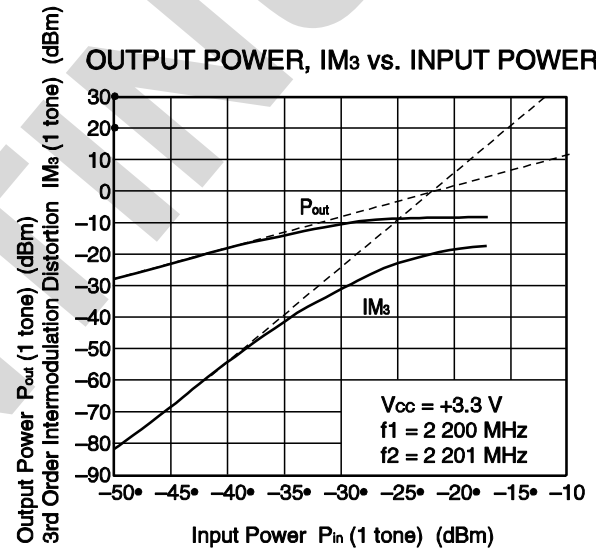
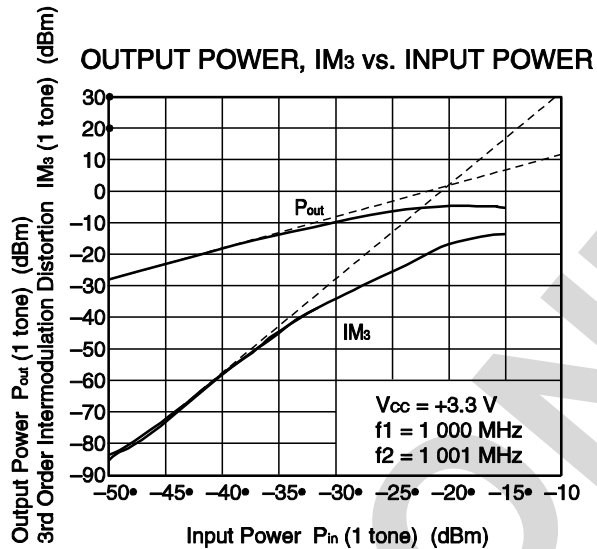
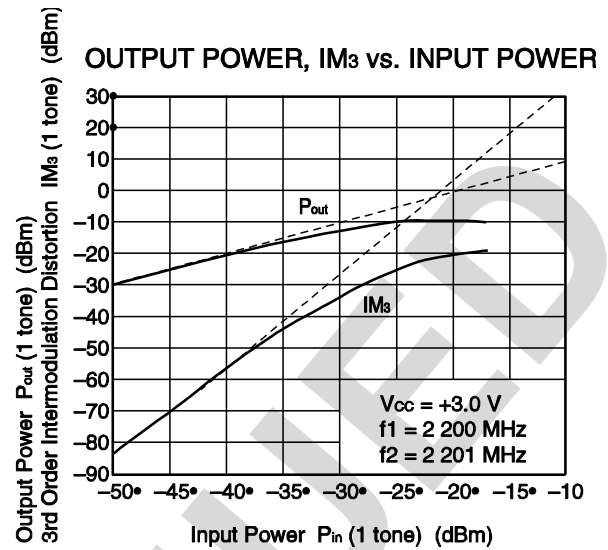
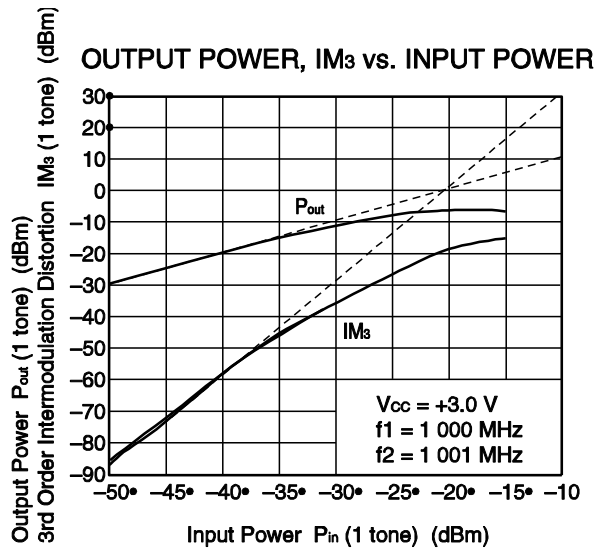


**Remark** The graphs indicate nominal characteristics.

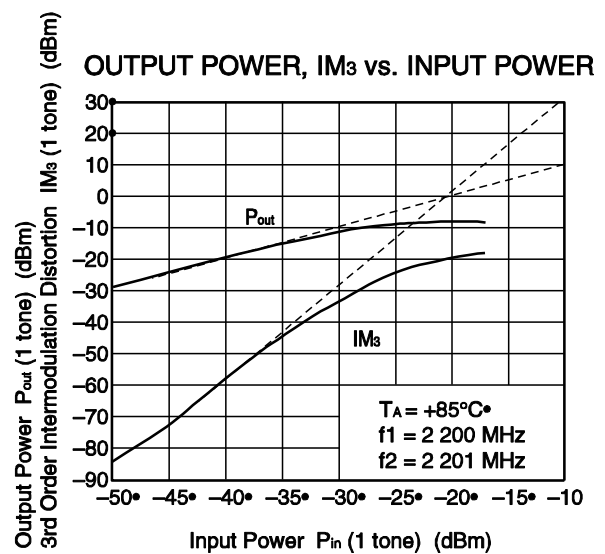
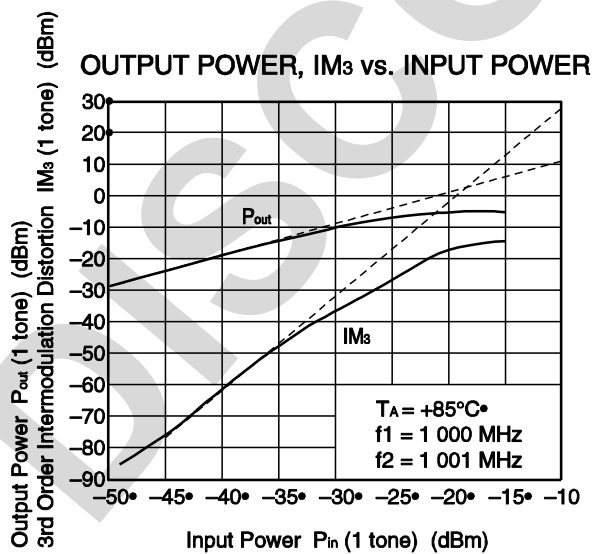
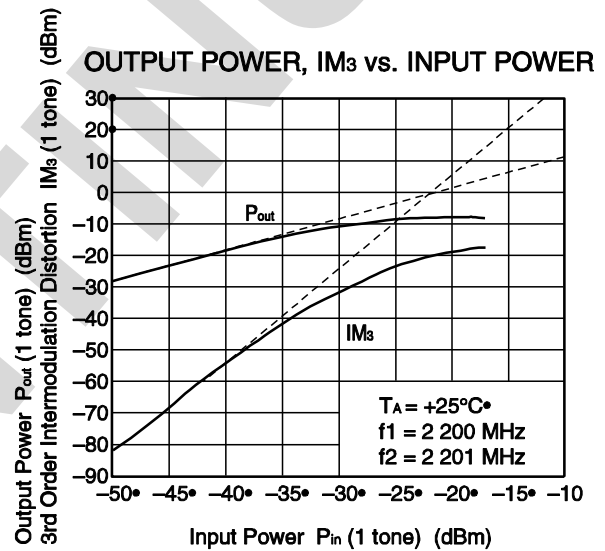
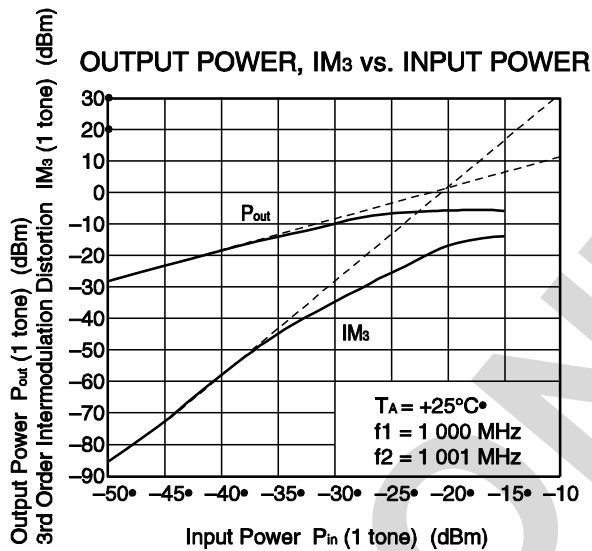
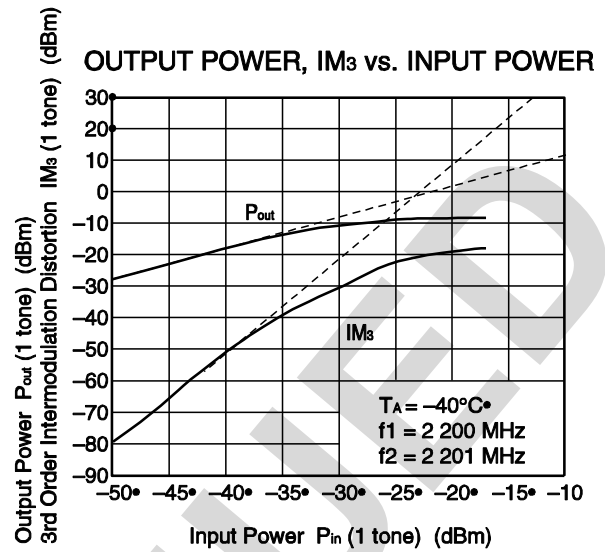
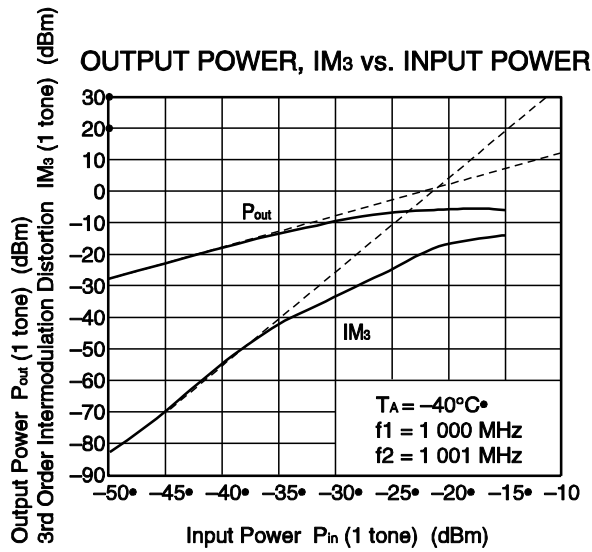




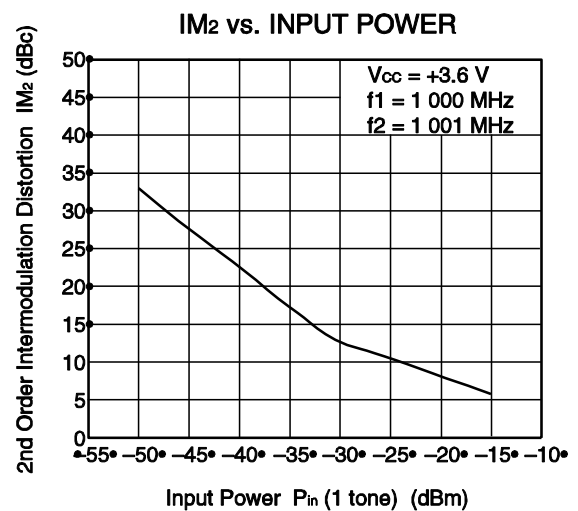
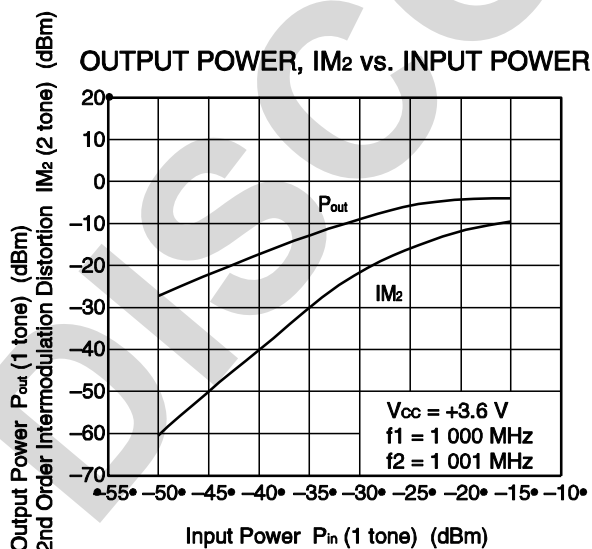
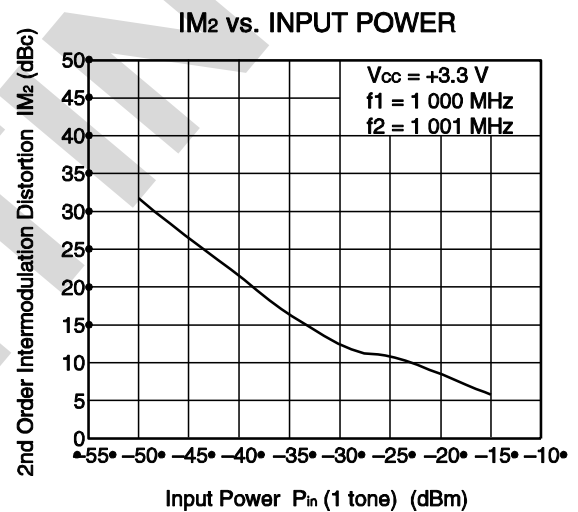
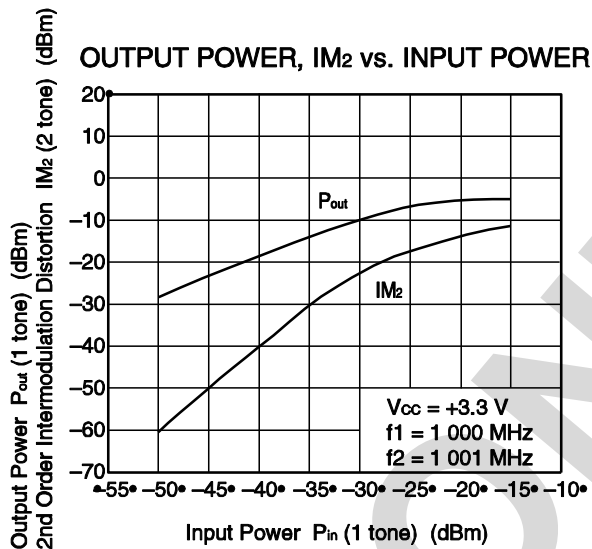
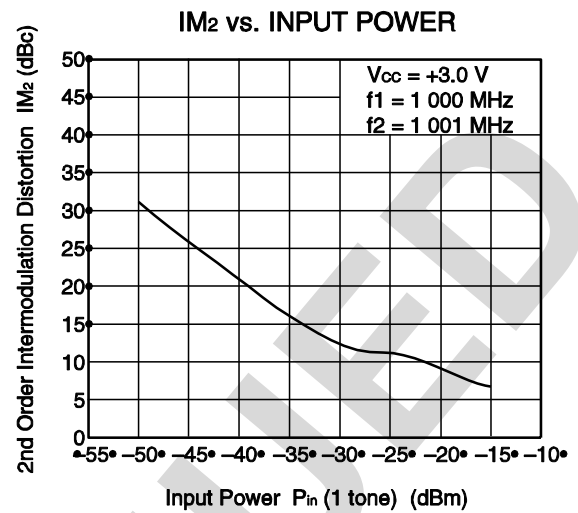
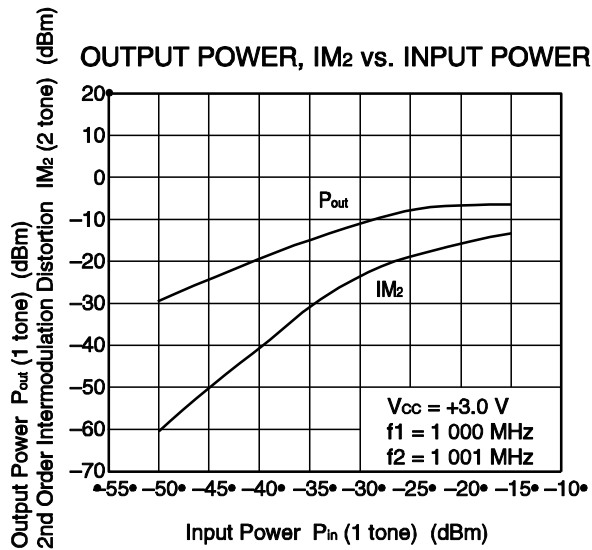
**Remark** The graphs indicate nominal characteristics.



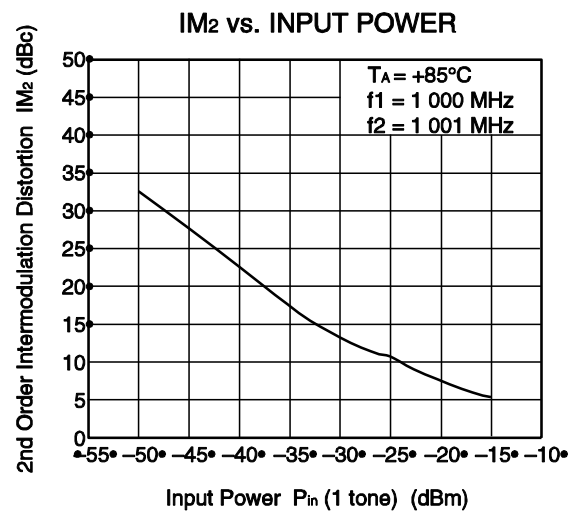
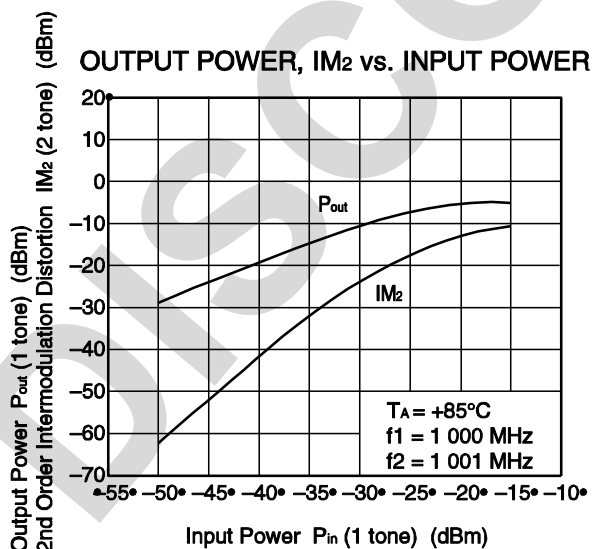
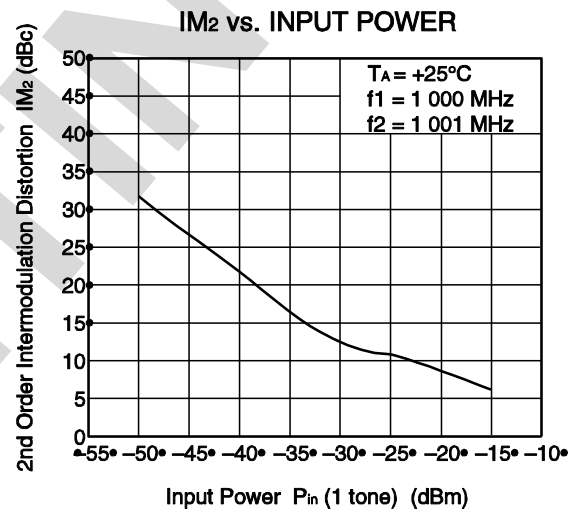
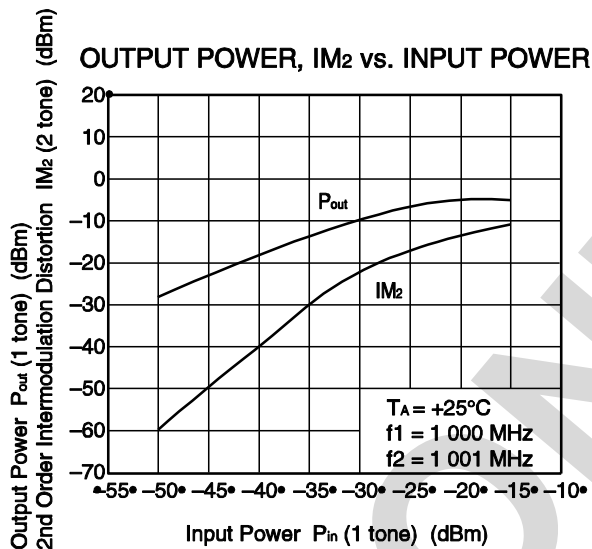
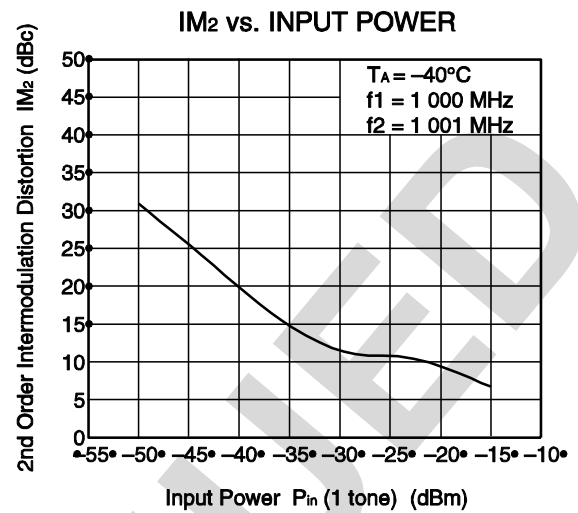
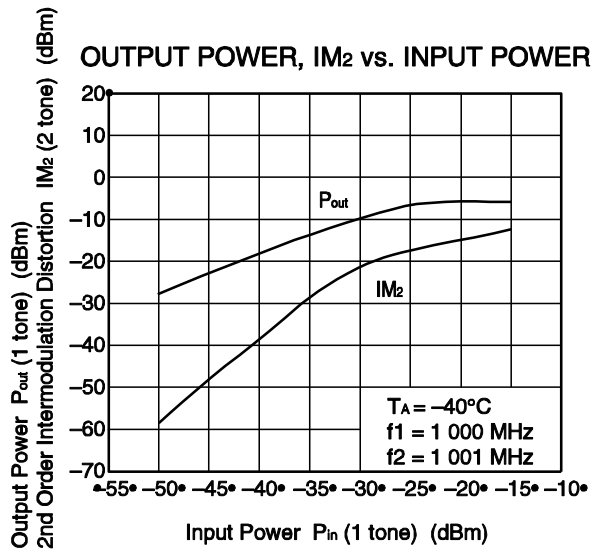
**Remark** The graphs indicate nominal characteristics.



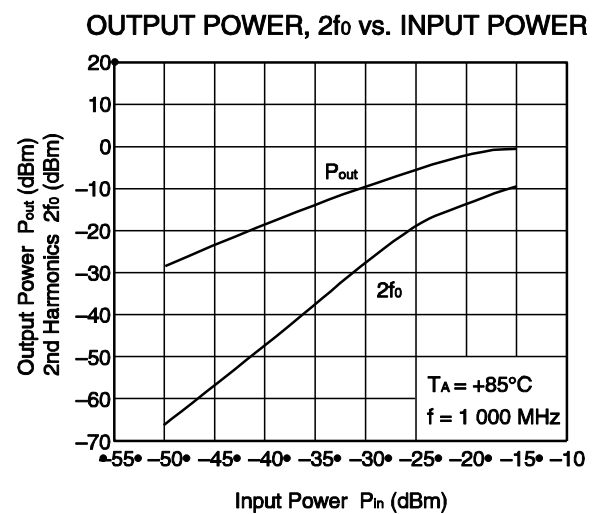
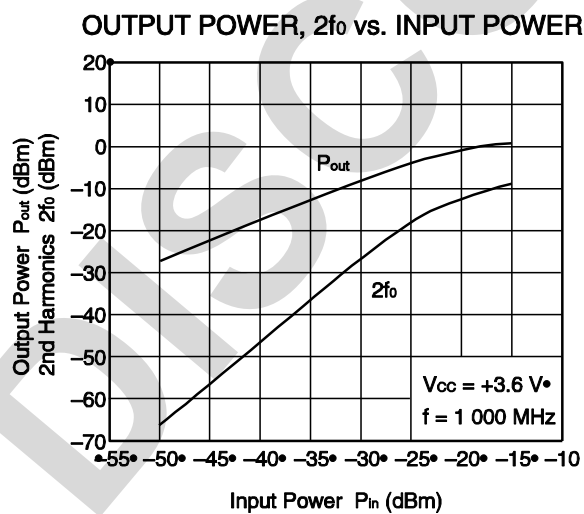
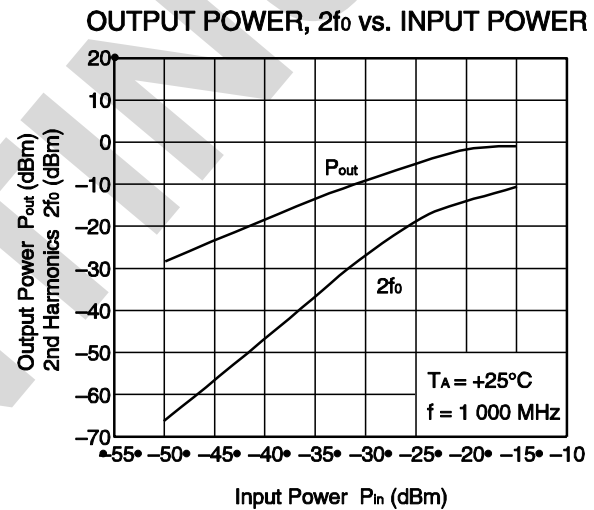
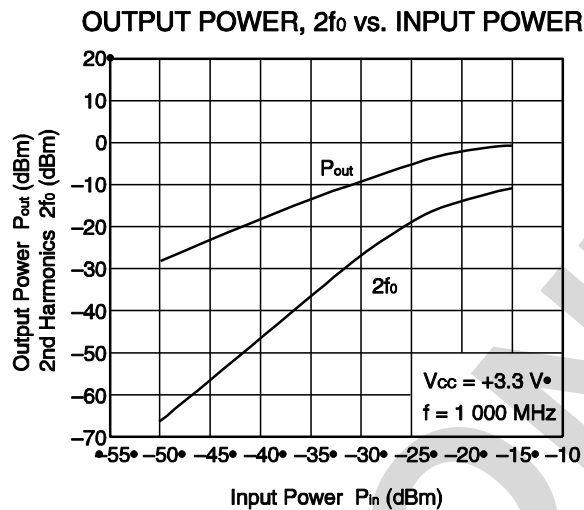
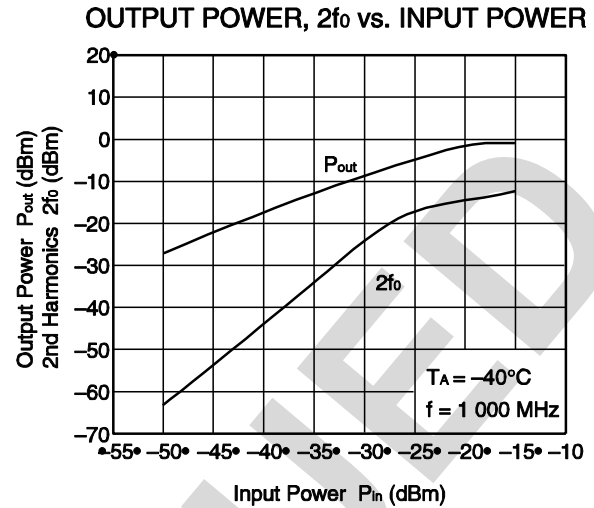
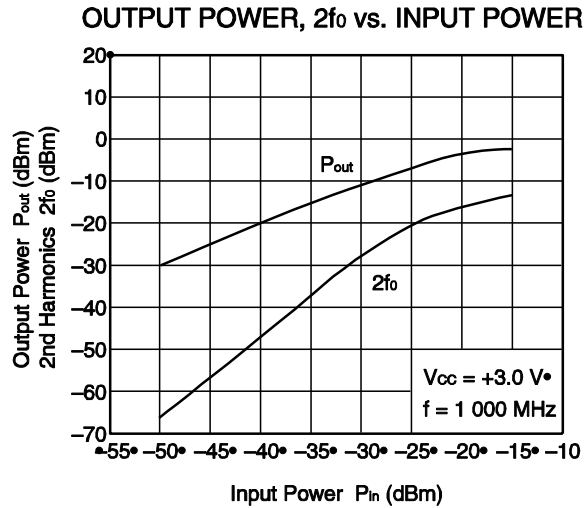
**Remark** The graphs indicate nominal characteristics.



**Remark** The graphs indicate nominal characteristics.



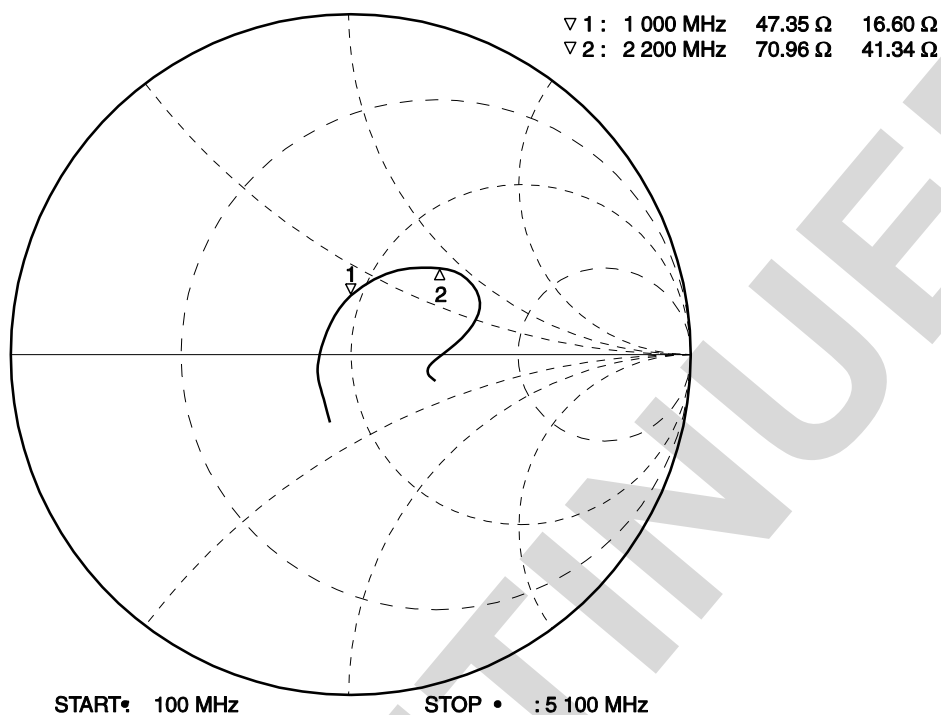
**Remark** The graphs indicate nominal characteristics.



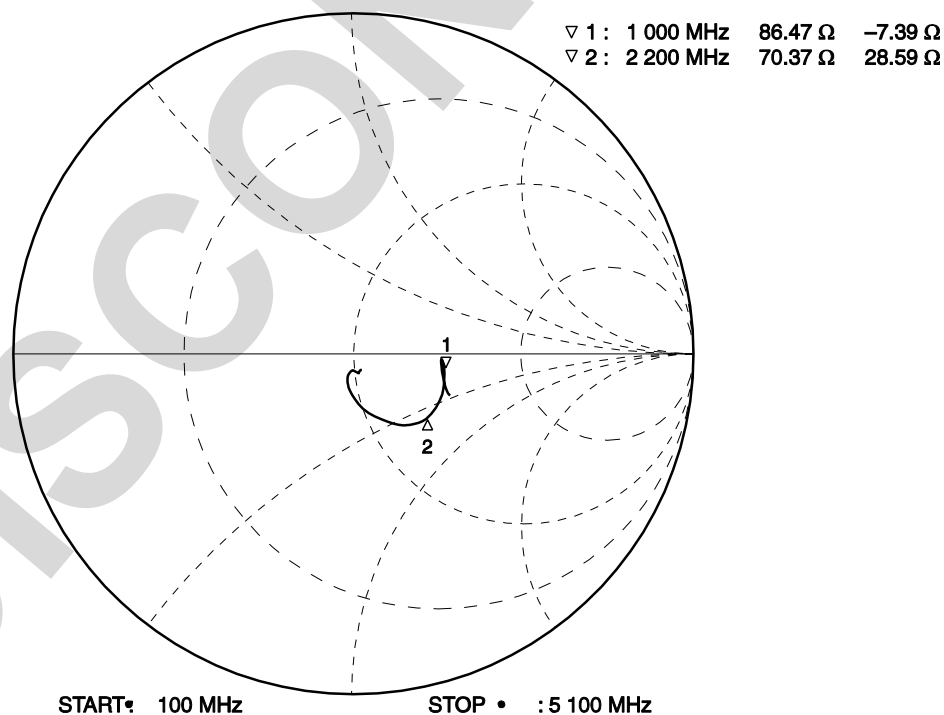
**Remark** The graphs indicate nominal characteristics.

**S-PARAMETERS** ( $T_A = +25^\circ\text{C}$ ,  $V_{CC} = 3.3\text{ V}$ ,  $P_{in} = -40\text{ dBm}$ )

**S<sub>11</sub>—FREQUENCY**



**S<sub>22</sub>—FREQUENCY**



**Remarks 1.** Measured on the test circuit of evaluation board.

**2.** The graphs indicate nominal characteristics.

**S-PARAMETERS**

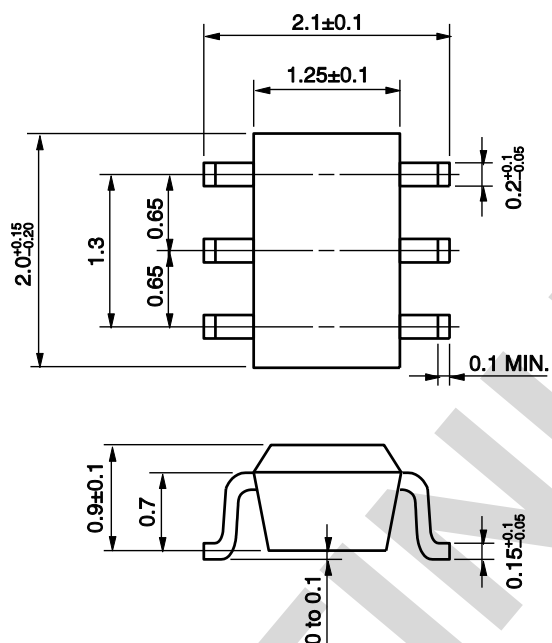
- S-parameters and noise parameters are provided on our Web site in a format (S2P) that enables the direct import of the parameters to microwave circuit simulators without the need for keyboard inputs.
- Click here to download S-parameters.
- [RF and Microwave] ® [Device Parameters]
- URL <http://www.necel.com/microwave/en/>

DISCONTINUED



## PACKAGE DIMENSIONS

6-PIN SUPER MINIMOLD (UNIT: mm)



**NOTES ON CORRECT USE**

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation).  
All the ground terminals must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to the V<sub>cc</sub> line.
- (4) The DC cut capacitor must be attached to input and output pin.

**RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) : 260°C or below Time at peak temperature : 10 seconds or less Time at temperature of 220°C or higher : 60 seconds or less Preheating time at 120 to 180°C : 120±30 seconds Maximum number of reflow processes : 3 times Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) : 260°C or below Time at peak temperature : 10 seconds or less Preheating temperature (package surface temperature) : 120°C or below Maximum number of flow processes : 1 time Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) : 350°C or below Soldering time (per side of device) : 3 seconds or less Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	HS350

**Caution** Do not use different soldering methods together (except for partial heating).